AMD最新テクノロジー アップデート

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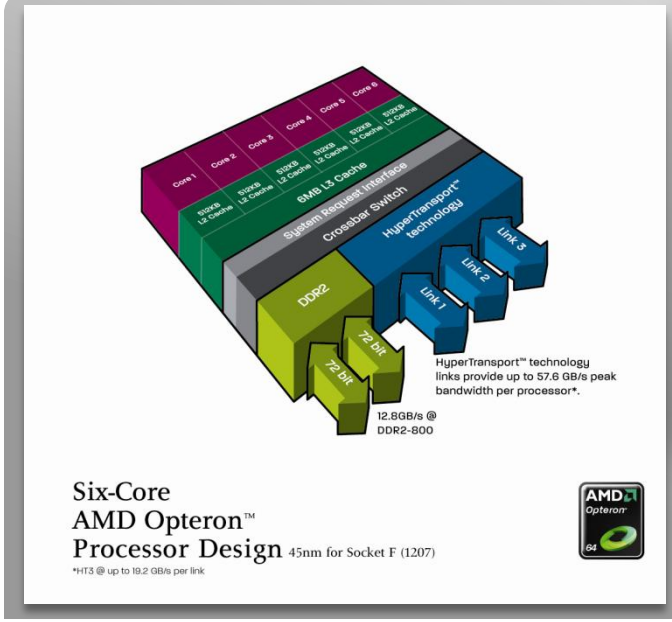
マーケティング＆ビジネス開発本部
コマーシャルマーケティング部
山野　洋幸

6コア AMD Opteron™ プロセッサ（コードネーム：Istanbul）のご紹介

6コア AMD Opteron™ プロセッサ（コードネーム：Istanbul）



- 本物の6つのコアを統合
- 新たなHyperTransport™ テクノロジ、HT Assist
- HyperTransport 3 technology (HT3) バンド幅の拡張
- 統合メモリコントローラの改良
- 従来のクアッドコア製品と同様の熱設計消費電力を実現

従来のクアッドコア製品に対して最大30%以上の性能向上！

Series	Model	Cores	Freq	NB	Wattage	L2 Cache	L3 Cache	Production
8000	8435	6	2.6GHz	2.2GHz	75W	512K/core	6MB	May
8000	8431		2.4GHz					
2000	2435		2.6GHz					
2000	2431		2.4GHz					
2000	2427		2.2GHz					
8000	8425 HE	6	2.1 GHz	2.2 GHz	55W	512K/core	6MB	July 3rd
2000	2425 HE		2.1 GHz					
2000	2423 HE		2.0 GHz					
8000	8439 SE	6	2.8 GHz	2.2 GHz	105W	512K/core	6MB	July 24th
2000	2439 SE		2.8 GHz					
2000	2419EE	6	1.8GHz	2.0GHz	40W	512K/core	6MB	September

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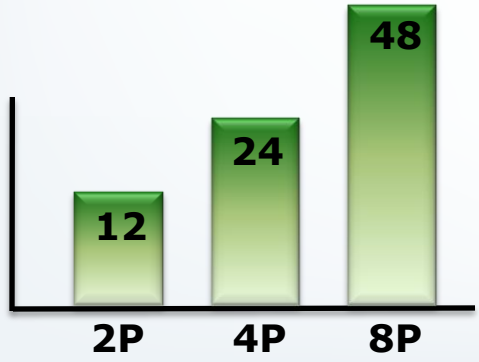
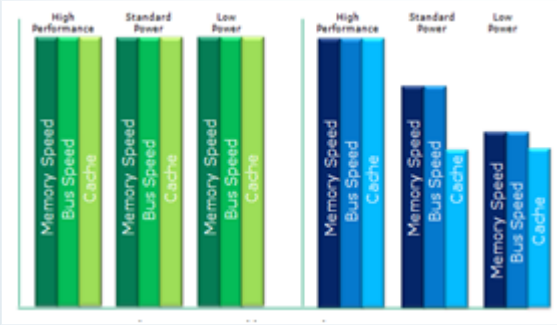
さらに使いやすく

トータル48コアまで スケーラブル



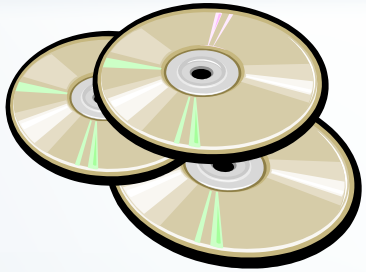
同じ消費電力で さらなる性能向上

すべての製品において 妥協のない機能実装

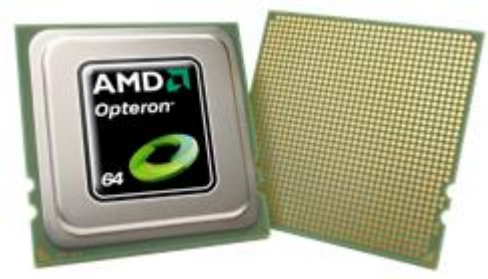


ソケット互換による アップグレード

システム移行を容易にする プラットフォーム互換性



SEからEEまで フルラインナップ**



*Compared to Quad-Core AMD Opteron processor codenamed "Shanghai." **Six-Core AMD Opteron™ EE and SE processors planned launch Q3 09.

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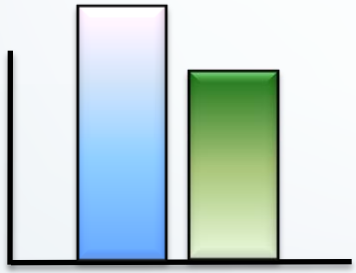
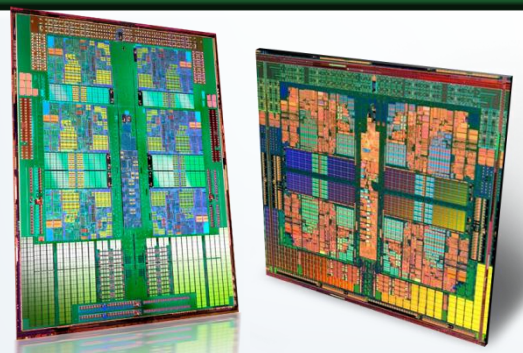
トータルコストでの優位性

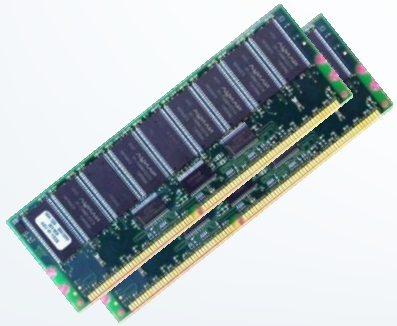
低コストプラットフォームで導入費用を削減



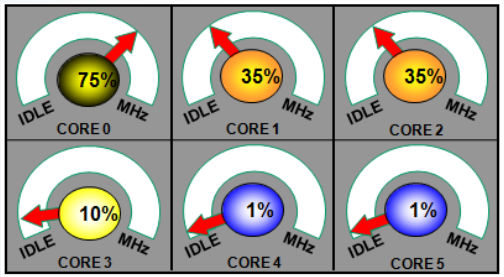
プラットフォームの一貫性が中長期の管理コストを削減



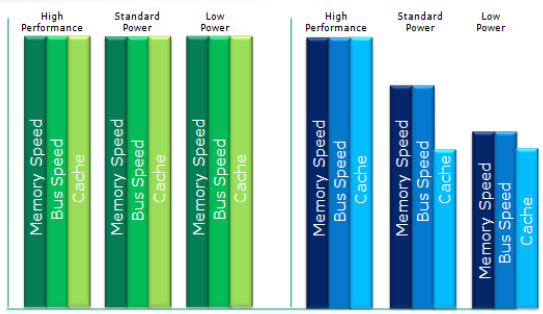
メモリアーキテクチャの継続によりシステムコストを削減



HE & EE 6コア低消費電力製品*



電力効率と省電力機能が運用コストを削減



すべての製品にすべての機能を提供

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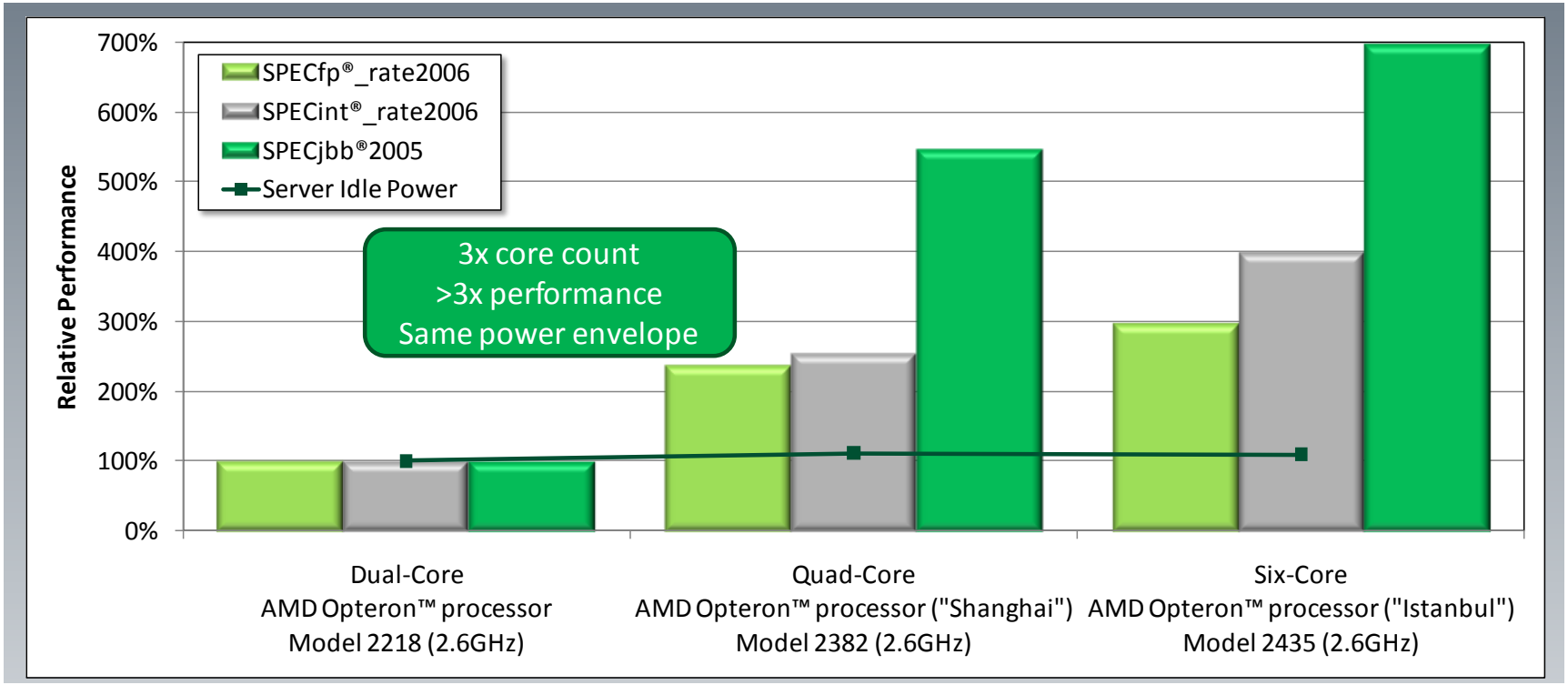
消費電力を変えることなくさらなる性能向上

6コア AMD Opteron™ プロセッサを搭載したサーバーは 従来のデュアルコア・クアッドコアOpteronを搭載したサーバーを 大きく上回る性能を同一の消費電力で実現



SPEC, SPECfp, SPECint, and SPECjbb are registered trademarks of the Standard Performance Evaluation Corporation. The performance results for Six-Core AMD Opteron™ processor Model 2435 and the SPECjbb result for Quad-Core AMD Opteron™ processor Model 2382 are based upon data submitted to Standard Performance Evaluation Corporation as of May 21, 2009. The other performance results stated below reflect results published on http://www.spec.org/ as of May 21, 2009. The server idle power results are based on measurements of server active idle power for 60 seconds at AMD performance labs as of May 21, 2009. The comparison presented below is based on the best performing two-socket servers using AMD Opteron™ processor Models 2218, 2382, and 2435. For the latest results, visit http://www.spec.org/. Please see backup slides for configuration information.

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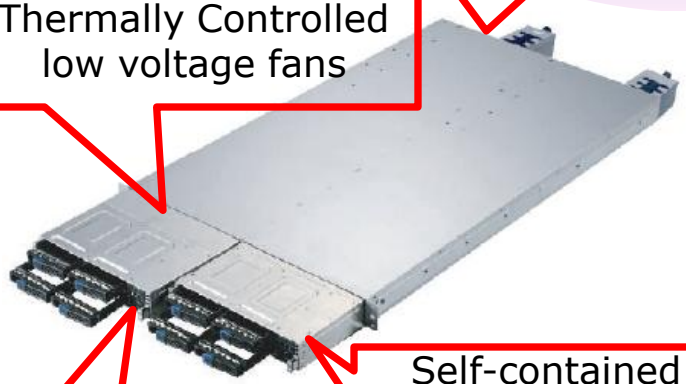
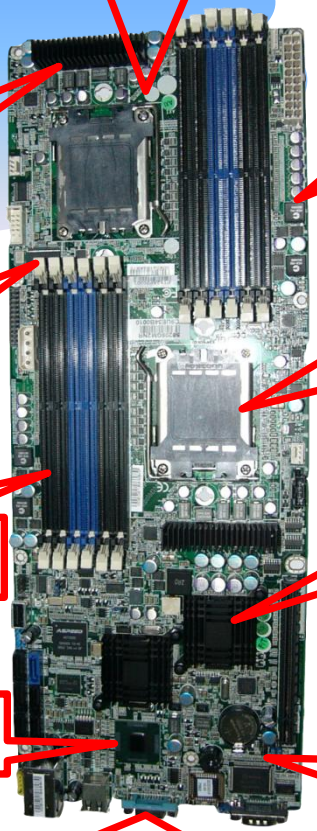
Cloud Usage-based Platform Enablement

Laser-focused on enabling ultra efficient platform "Kroner"

Tyan Model 8208 - Design based on target customer feedback





RPMI Support

Motherboard layout / Component Placement

Highly Efficient Power Supplies

CPU Voltage Regulators

Thermally Controlled low voltage fans

Optimized for HE and EE processors

MEMORY Voltage Regulators

# of DIMMs

AMD Chipset

Self-contained Modular design (serviceability)

IMC

BIOS Settings

2.5" drive support

On Board Video

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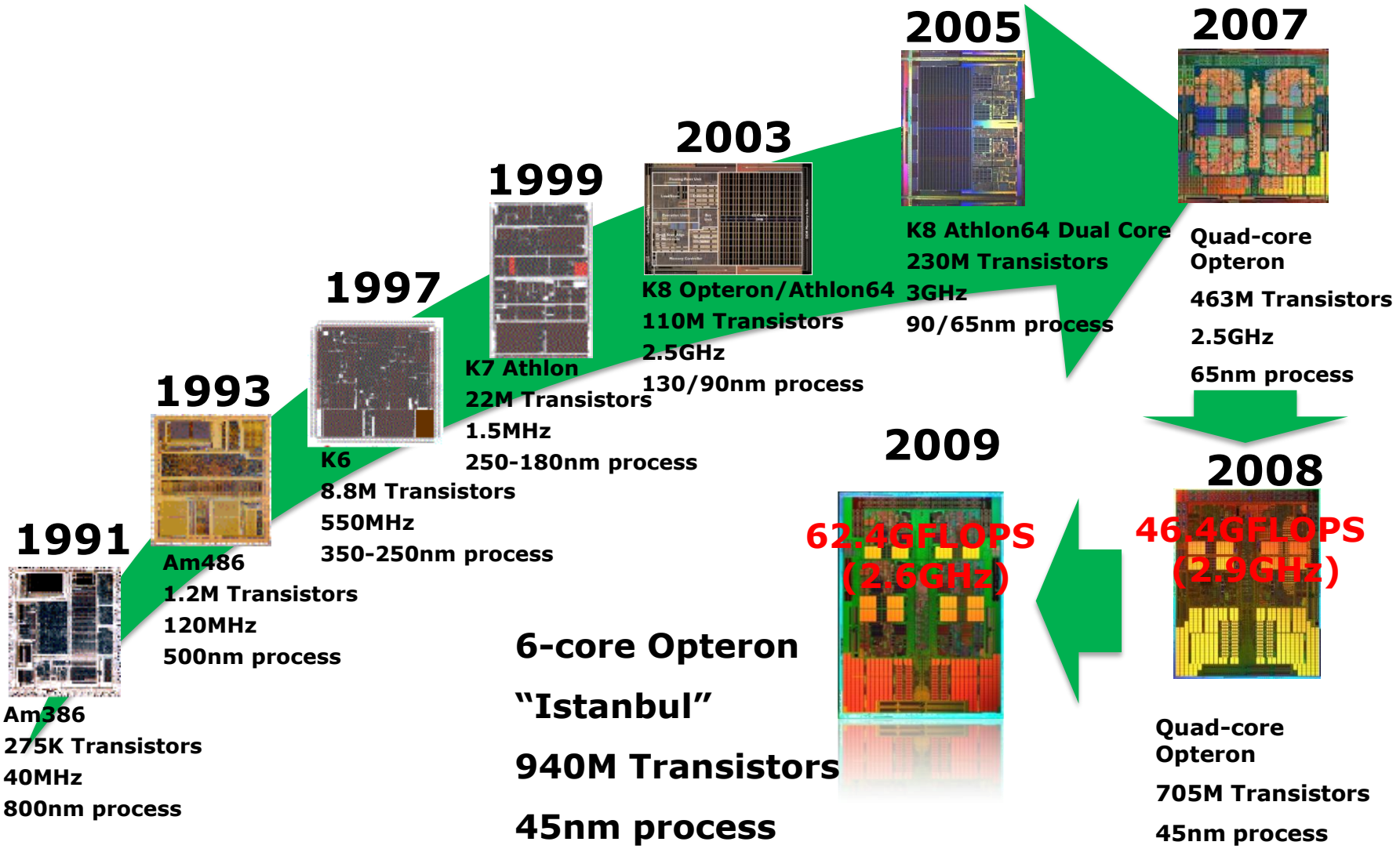
AMD Opteron™ プロセッサ
最新ロードマップのご紹介

AMDプロセッサの進化の軌跡



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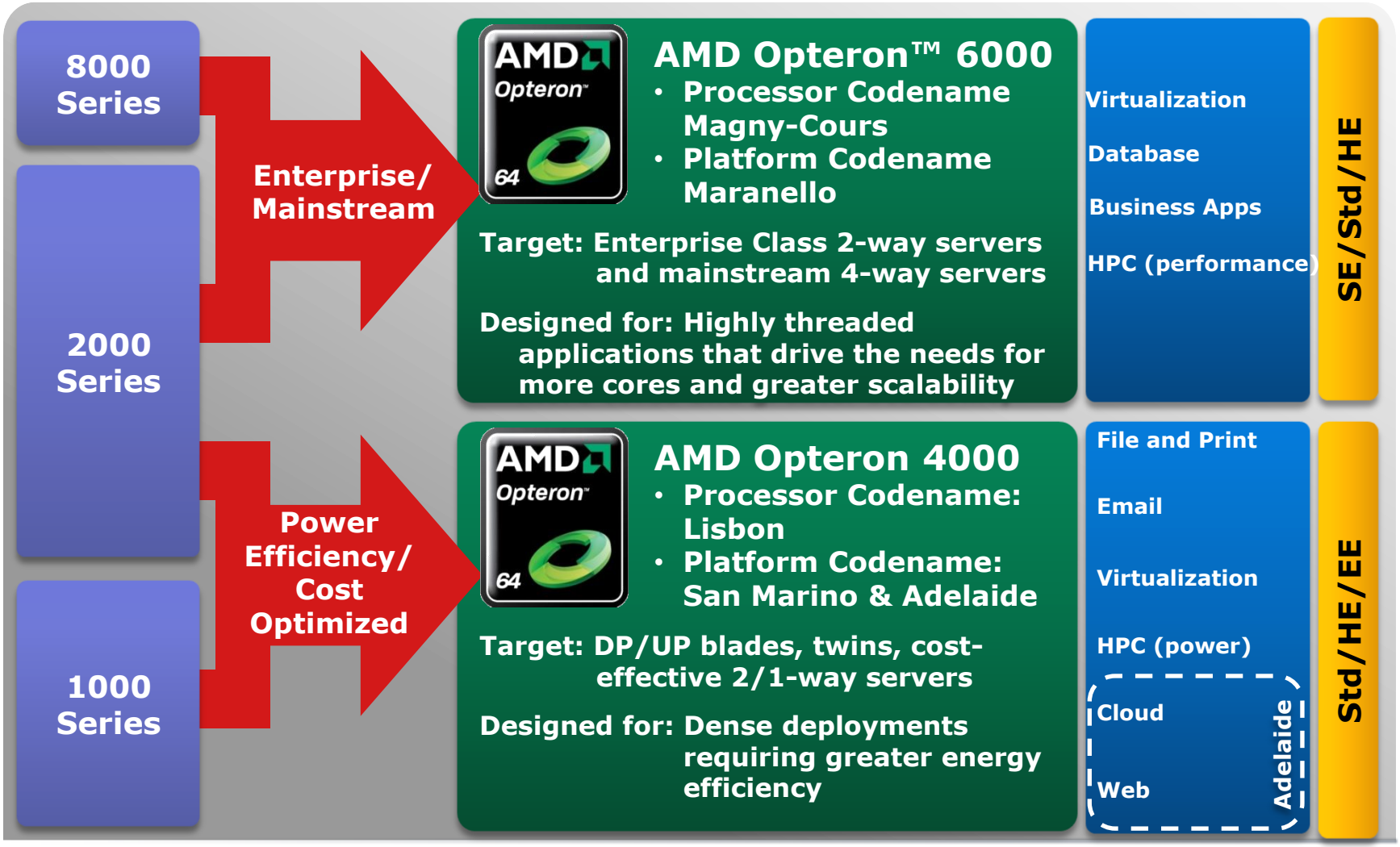
Product Positioning



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AMD Opteron™ プロセッサ ロードマップ

65nm 45nm 32nm

Platform Segment	2009	2010	2011
4-way Performance Platform	**Shanghai** 4-Core •6M L3 •3x HT-3 (4.4GT) •AMD-V technology •RDDR2 (Dual-Channel) **Istanbul** 6-Core •6M L3 •3x HT-3 (4.8GT) •HT Assist •AMD-V technology •RDDR2 (Dual-Channel) **"Socket F (1207)"** "Six-Core AMD Opteron™ Processor w/AMD Chipset" •AMD SR56x0 ● AMD SP5100 ● APML Enabled (Istanbul Only)		
2 and 4-way Enterprise/Mainstream Platform		**Magny-Cours** 8/12-Core •12M L3 •4x HT-3 (6.4GT) •U/RDDR3 & LV RDDR3 (Quad-Channel) •Cool Speed •C1E •AMD-V •HT Assist	**Interlagos** 12/16-Core New Core **"Maranello"** "Maximum Scalability" •AMD SR56x0 •AMD SP5100 •Advanced Platform Management
2-way Mainstream Platform	**Shanghai** 4-Core **Istanbul** 6-Core **"Socket F (1207)"** "Six-Core AMD Opteron™ Processor with AMD Chipset"		
1 and 2-way Energy Efficient/Cost Optimized Platform		**Lisbon** 4/6-Core •6M L3 •2x HT-3 (6.4GT) •U/RDDR3 & LV RDDR3 (Dual-Channel) •Cool Speed •C1E •HT Assist • AMD-V	**Valencia** 6/8-Core New Core **"San Marino" (Std/HE/EE)** "Optimized Energy Efficiency" •AMD SR56x0 •AMD SP5100 •Advanced Platform Management **"Adelaide" (EE Only)** "Ultra Low Power" •AMD SR5650 •AMD SP5100 •LV DDR3 •HT1
1-way Platform	**Budapest** 4-Core **Suzuka** 4-Core •6M L3 •DDR3 •1xHT3 •AMD-V technology **"Socket AM2+"** **"Buenos Aires"** •AMD SR56x0 •AMD SP5100		

Green denotes new feature

グラフィックス製品・GPGPUの動向

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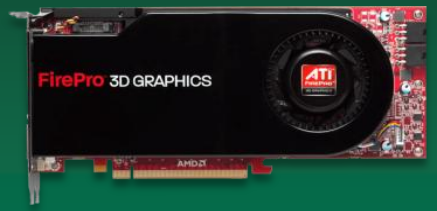
ATI Stream Development and Deployment

Development

Deployment

ATI Radeon™ graphics
for consumer applications



ATI FirePro™ graphics
for professional graphics

AMD FireStream™ compute accelerator
for computation

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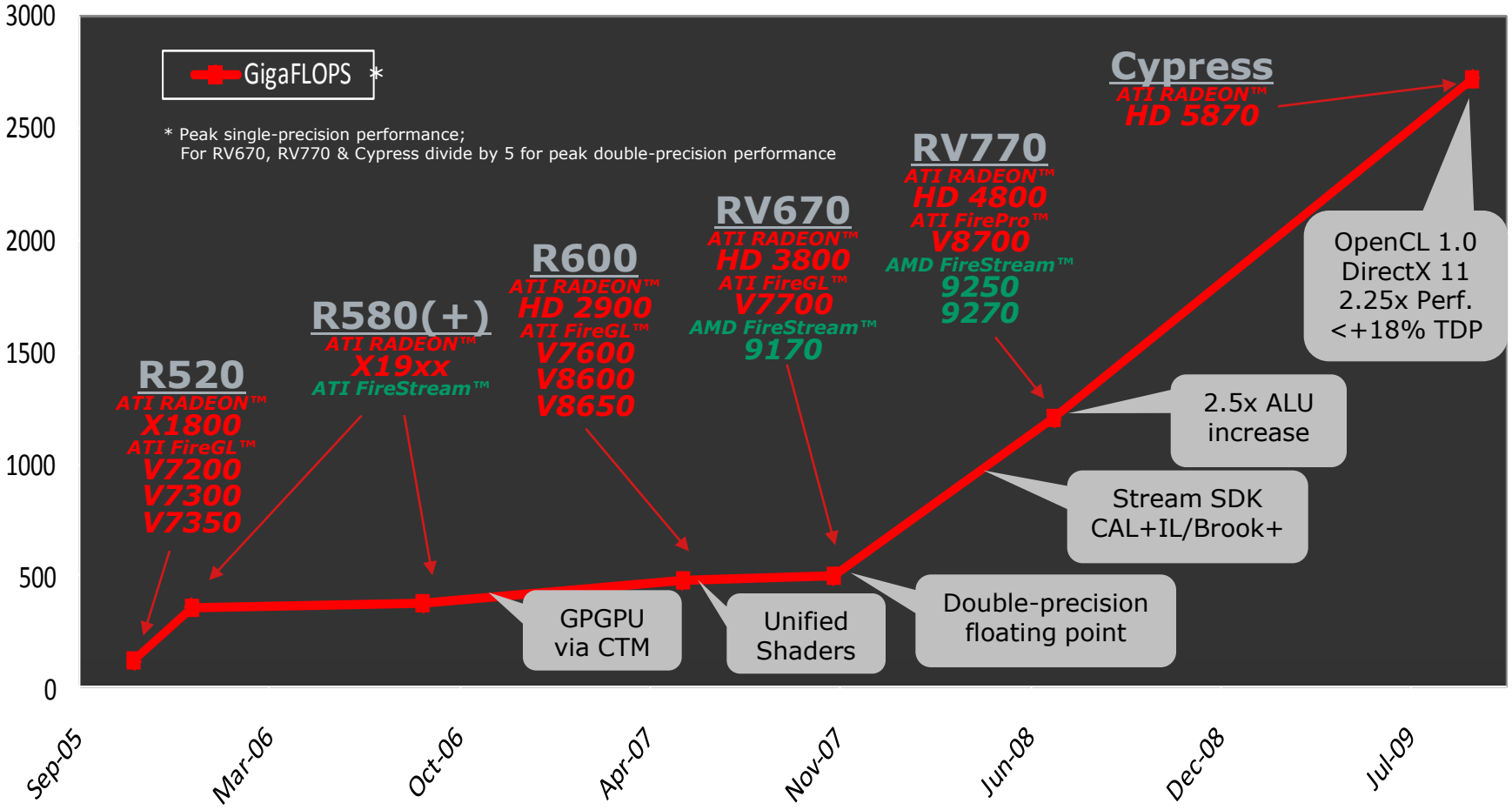
GPGPU Processing Power Trend



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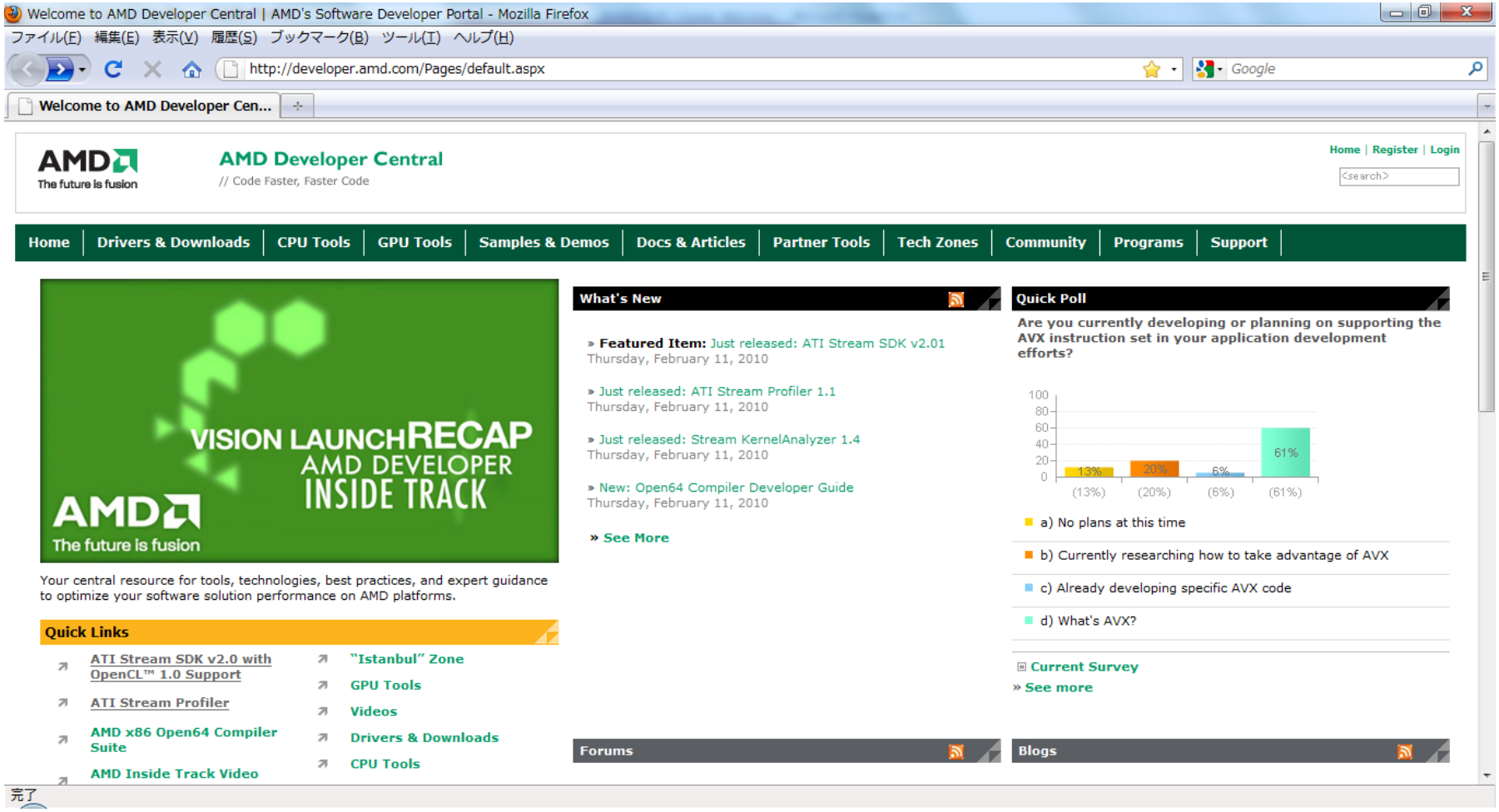
AMD Developer Central (http://developer.amd.com)



ONLY AMD!

CPU

GPU

Only AMD

ATI STREAM TECHNOLOGY

OpenCL

KHRONOS GROUP

DirectCompute

Microsoft

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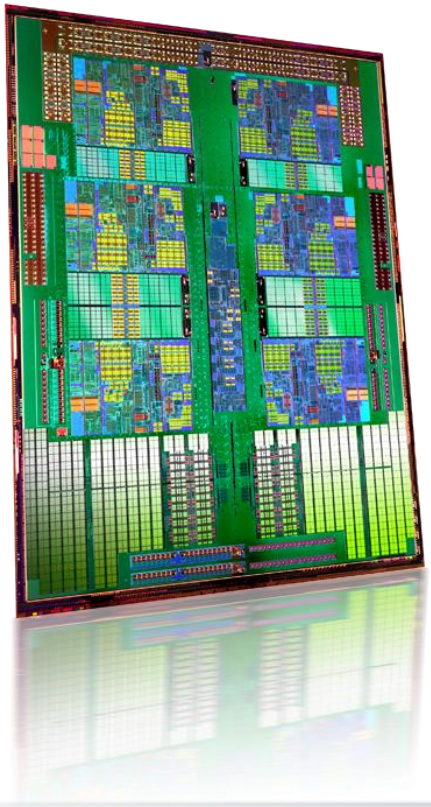
Thank You !!

Hiroyuki.Yamano@amd.com



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